

# IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT(S):

Wu et al.

SERIAL NO.:

10/603,852

**GROUP NO.:** 

2811

FILING DATE:

June 25, 2003

**EXAMINER:** 

Not yet assigned

TITLE:

ETCH STOP LAYER SYSTEM

## CERTIFICATE OF FIRST CLASS MAILING UNDER 37 C.F.R. 1.8

I hereby certify that this correspondence, and any document(s) referred to as enclosed herein, is/are being deposited with the United States Postal Service as first class mail, postage prepaid, in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on this property day of January, 2004.

Marna Pattaropong

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

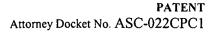
#### Submitted herewith are:

- 1. Transmittal Form (1 pg.);
- 2. Supplemental Information Disclosure Statement (2 pgs.);
- 3. Form PTO-1449 (3 pgs.);
- 4. Cited References C43-C69;
- 5. Return Receipt Postcard; and
- 6. Certificate of First Class Mailing.

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6	it.		Application	Serial Number	1	10/603,852	
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\			First Named	Inventor	7	Wu	
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TRANSMITTAL			Examiner N	Examiner Name		Not yet assigned	
	FORM		Attorney Do	ocket No.	7	ASC-022CPC1	
			Patent No.		1	Not applicable	
			Issue Date		1	Not applicable	
		FN	CLOSURES (c	heck all that apply)			
☐ Fee	Transmittal Form			e to File Missing		Notice of Appeal to Board	
		_	Parts of Applic			of Patent Appeals and Interferences	
	☐ Check Attached☐ Copy of Fee		Formal Drawin	ıg(s)		Appeal Brief (in triplicate)	
	Transmittal Form						
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$\boxtimes$	Supplemental Information Disclosure Statement		Small Entity S	tatement			
	Form PTO-1449						
	Copies of IDS Citations (C43-C69)		CD(s) for large program	e table or computer			
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	Certified Copy of Priority Document(s)		Amendment A	fter Allowance			
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CORRESPONDENCE ADDRESS				SIGNATURE BL	оск		
Direct all correspondence to: Patent Administrator			r			Respectfully submitted,	
Testa, Hurwitz & Thibeault, LL High Street Tower			nibeault, LLP	~		0.11	
	125 High			Date: January $\mathcal{L}$ , 2 Reg. No. 44,381	2004	Natasha C. Us	
	Boston, M	1A 02110		Tel. No.: (617) 310-		7 Attorney for Applicants	
		(617) 248- (617) 248-		Fax No.: (617) 248-	-7100	Testa, Hurwitz & Thibeault, LLP High Street Tower	
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						Boston, MA 02110	

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Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

## SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Sir:

In accordance with the provisions of 37 C.F.R. 1.97 and 1.98, Applicants hereby make of record the patents and publications listed on the accompanying Form PTO-1449, and other information contained herein, for consideration by the Examiner in connection with the examination of the above-identified patent application. Copies of the publications are enclosed.

#### **REMARKS**

In accordance with the provisions of 37 C.F.R. 1.97, this statement is being filed (CHECK ONE):

(1)	within three (3) months of the <b>filing date</b> of a national application other than a continued prosecution application under 37 C.F.R. 1.53(d), or within three (3) months of the <b>date of entry of the national stage</b> as set forth in 37 C.F.R. 1.491 in an international application, or before the mailing of the <b>first Office action</b> on the merits, or before the mailing of a <b>first Office action</b> after the filing of a request for continued examination under 37 C.F.R. 1.114; or
(2)	after the period defined in (1) but before the mailing date of a <b>final action</b> or a <b>notice</b> of allowance under 37 C.F.R. 1.311, and
	the requisite Statement is below, <b>OR</b>
	the requisite fee under 37 C.F.R. 1.17(p), namely \$180.00, is included herein, or

Information Disclosure Statement Serial No. 10/603,852 Page 2 of 2

(3)	after the mailing date of a final action or notice of allowance but before the payment of the issue fee, AND
	the requisite Statement is below, AND
	the requisite petition fee under 37 C.F.R. 1.17(p), namely \$180.00 is included herein.

It is respectfully requested that each of the patents and publications listed on the attached Form PTO-1449, and other information contained herein, be made of record in this application.

Applicants believe that no fees are due for this paper to be entered and considered, but the Commissioner is hereby authorized to charge Deposit Account No. 20-0531 for any required fees that may be due.

Respectfully submitted,

Attorney for Applicants

Date: January 8, 2004

Reg. No. 44,381

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Boston, Massachusetts 02110

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3001047



**FORM PTO - 1449** 

SUPPLEMENTAL INFORMATION

ATTORNEY DOCKET NO.: ASC-022CPC1

APPLICANT(S): Wu et al.

#### DISCLOSURE STATEMENT SERIAL NO.: 10/603,852 FILING DATE: June 25, 2003 GROUP: 2811 U.S. PATENT DOCUMENTS DATE NAME CLASS SUB EXAM. **DOCUMENT** FILING DATE IF INIT. NUMBER **CLASS** APPROPRIATE FOREIGN PATENT DOCUMENTS DOCUMENT DATE COUNTRY **CLASS** ENGLISH EXAM. SUB FILING ABSTRACT NUMBER INIT. CODE CLASS DATE LANG ONLY (Y/N) OTHER ART, JOURNAL ARTICLES, ETC. EXAM. OTHER DOCUMENTS: (Including Author, Title, Date, Relevant Pages, Place of Publication) INIT. C43 Batterman, "Hillocks, Pits, and Etch Rate in Germanium Crystals," Journal of Applied Physics, Vol. 28, No. 11 (November, 1957), pp. 1236-1241. C44 Bohg, "Ethylene Diamine-Pyrocatechol-Water Mixture Shows Etching Anomaly in Boron-Doped Silicon," Journal of the Electrochemical Society, Vol. 118, No. 2 (February 1971), pp. 401-402. C45 Desmond et al., "The Effects of Process-Induced Defects on the Chemical Selectivity of Highly Doped Boron Etch Stops in Silicon," Journal of the Electrochemical Society, Vol. 141, No. 1 (January 1994), pp. C46 Ehman et al., "Morphology of Etch Pits on Germanium Studied by Optical and Scanning Electron Microscopy," Journal of Applied Physics, Vol. 41, No. 7 (June 1970), pp. 2824-2827. C47 Feijóo et al., "Etch Stop Barriers in Silicon Produced by Ion Implantation of Electrically Non-Active Species," Journal of the Electrochemical Society, Vol. 139, No. 8 (August 1992), pp. 2309-2313. C48 Fitzgerald, "GeSi/Si Nanostructures," Annual Review of Materials Science, Vol. 25 (1995), pp. 417-454. Frank, "Orientation-Dependent Dissolution of Germanium," Journal of Applied Physics, Vol. 31, No. 11 C49 (November 1960), pp.1996-1999. **EXAMINER** DATE CONSIDERED



**FORM PTO - 1449** 

# SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

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APPLICANT(S): Wu et al.

SERIAL NO.: 10/603,852

FILING DATE: June 25, 2003 GROUP: 2811

		TILING DATE. Julie 25, 2005 GROOP. 2811		
		OTHER ART, JOURNAL ARTICLES, ETC.		
EXAM. INIT.	ОТН	ER DOCUMENTS: (Including Author, Title, Date, Relevant Pages, Place of Publication)		
<del>- 11 - 1</del> - 1 - 1 - 1 - 1 - 1 - 1 - 1 -	C50	Ghandi et al., "Chemical Etching of Germanium," <u>Journal of the Electrochemical Society</u> , Vol. 135, No. 8 (August 1988), pp.2053-2054.		
	C51	Herzog et al., "X-Ray Investigation of Boron- and Germanium-Doped Silicon Epitaxial Layers," <u>Journal of the Electrochemical Society</u> , Vol. 131, No. 12 (December 1984), pp.2969-2974.		
	C52	Holmes, "The Orientation Dependence of Etching Effects on Germanium Crystals," <u>Acta Metallurgica</u> , Vol. 7, No. 4 (April 1959), pp. 283-290.		
	C53	Hunt et al., "Selective Etch Stop by Stress Compensation for Thin-Film BESOI," 1990 IEEE/SOI Technology Conference, (October 2-4, 1990), pp.145-146.		
	C54	Jaccodine, "Use if Modified Free Energy Theorems to Predict Equilibrium Growing and Etching Shapes," <u>Journal of Applied Physics</u> , Vol. 33, No. 8 (August 1962), pp. 2643-2647.		
	C55	Kern, "Chemical Etching of Silicon, Germanium, Gallium, Arsenide, and Gallium Phosphide," Review, Vol. 39 (June 1978), pp. 278-308.		
	C56	Lang et al., "Bulk Micromachining of Ge for IR Gratings," <u>Journal of Micromechanics and Microengineering</u> , Vol. 6, No.1 (March 1996), pp. 46-48.		
	C57	Leancu et al., "Anisotropic Etching of Germanium," Sensors and Actuators, A46-47 (1995), pp. 35-37.		
·	C58	Lehmann <i>et al.</i> , "Implanted Carbon: An Effective Etch-Stop in Silicon," <u>Journal of the Electrochemical Society</u> , Vol. 138, No.5 (May 1991), pp. 3-4.		
	C59	Palik et al., "Ellipsometric Study of the Etch-Stop Mechanism in Heavily Doped Silicon," <u>Journal of the Electrochemical Society</u> , Vol. 132, No. 1 (January 1985), pp. 135-141.		
	C60	Palik et al., "Study of Bias-Dependent Etching of Si in Aqueous KOH," <u>Journal of the Electrochemical</u> <u>Society</u> , Vol. 134, No. 2 (February 1987), pp. 404-409.		
	C61	Palik et al., "Study of the Etch-Stop Mechanism in Silicon," <u>Journal of the Electrochemical Society</u> , Vol. 129, No. 9 (September 1982), pp.2051-2059.		
	C62	Petersen et al., "Silicon as a Mechanical Material," Proceedings of the IEEE, Vol. 70, No. 5 (May 1982), pp. 420-457.		
	C63	Rai-Choudhury et al., "Doping of Epitaxial Silicon," <u>Journal of Crystal Growth</u> , Vol. 7 (1970), pp. 361-367.		
EXAMIN	EXAMINER DATE CONSIDERED			



**FORM PTO - 1449** 

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OTHER ART, JOURNAL ARTICLES, ETC.				
EXAM. INIT.	1. OTHER DOCUMENTS: (Including Author, Title, Date, Relevant Pages, Place of Publication)			
	C64	Raley <i>et al.</i> , "(100) Silicon Etch-Rate Dependence on Boron Concentration in Ethylenediamine-Pyrocatechol-Water Solutions," <u>Journal of the Electrochemical Society</u> , Vol. 131, No. 1 (January 1984), pp. 161-170.		
:	C65	Senna et al., "Gallium Doping for Silicon Etch Stop in KOH," <u>Transducers '95/Eurosensors IX</u> , the 8 <sup>th</sup> International Conference on Solid-State Sensors and Actuators and Eurosensors IX, Stockholm, Sweden, June 25-29, 1995, pp. 194-195.		
	C66	Soderbarg, "Fabrication of BESOI Materials Using Implanted Nitrogen as an Effective Etch Stop Barrier," 1989 IEEE SOS/SOI Technology Conference, (October 3-5, 1989), pp. 64.		
	C67	Sundaram <i>et al.</i> , "Electrochemical etching of Silicon by Hydrazine," <u>Journal of the Electrochemical Society</u> , Vol. 140, No. 6 (June 1993), pp.1592-1597.		
	C68	Sze, "Physics of Semiconductor Devices," (1991).		
	C69 Vol'fson et al., "Fundamental Absorption Edge of Silicon Heavily Doped with Donor or Acceptor Impurities," Soviet Physics Semiconductors, Vol. 1, No. 3 (September 1967), pp. 327-332.			
EXAMINER DATE CONSIDERED				

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